■ Insertion Loss Characteristics (Main)

NFM3DCC222R1H3

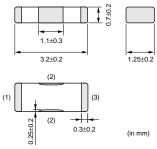
NFM3DCC102R1H3 NFM3DCC471R1H3 NFM3DCC221R1H3 NFM3DCC101UH3 NFM3DCC470U1H3 NFM3DCC220U1H3

Data Sheet

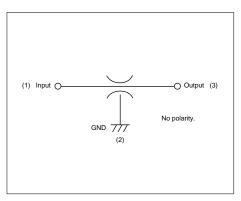
Chip EMIFIL® Capacitor Type Chip EMIFIL®

NFM3DC Series (1206 Size)

■ Dimension



■ Equivalent Circuit



■ Packaging

Insertion Loss (dB)

Code	Packaging	Minimum Quantity	
L	180mm Embossed Tape	4000	
В	Bulk(Bag)	500	

Frequency (MHz)

■ Rated Value (□: packaging code)

Part Number	Capacitance	Rated Current	Rated Voltage	Insulation Resistance (min.)	Operating Temperature Range
NFM3DCC220U1H3□	22pF+50%-20%	300mA	50Vdc	1000M ohm	-55°C to +125°C
NFM3DCC470U1H3□	47pF+50%-20%	300mA	50Vdc	1000M ohm	-55°C to +125°C
NFM3DCC101U1H3□	100pF+50%-20%	300mA	50Vdc	1000M ohm	-55°C to +125°C
NFM3DCC221R1H3□	220pF+50%-20%	300mA	50Vdc	1000M ohm	-55°C to +125°C
NFM3DCC471R1H3□	470pF+50%-20%	300mA	50Vdc	1000M ohm	-55°C to +125°C
NFM3DCC102R1H3□	1000pF+50%-20%	300mA	50Vdc	1000M ohm	-55°C to +125°C
NFM3DCC222R1H3□	2200pF+50%-20%	300mA	50Vdc	1000M ohm	-55°C to +125°C
NFM3DCC223R1H3□	22000pF+50%-20%	300mA	50Vdc	1000M ohm	-55°C to +125°C

Number of Circuit: 1

Continued on the following page.

1000 2000

This data sheet is applied for CHIP EMIFIL® used for General Electronics equipment for your design.

⚠ Note:

- 1. This datasheet is downloaded from the website of Murata Manufacturing co., ltd. Therefore, it's specifications are subject to change or our products in it may be discontinued without advance notice. Please check with our sales representatives or product engineers before ordering.
- 2. This datasheet has only typical specifications because there is no space for detailed specifications. Therefore, please approve our product specifications or transact the approval sheet for product specifications before ordering.

Noise Suppression Products/EMI Suppression Filters > Chip EMIFIL® Capacitor Type > Chip EMIFIL® **Data Sheet**

Continued from the preceding page.

■ ①Caution/Notice

Do not use products beyond the rated current and rated voltage as this may create excessive heat and deteriorate the insulation resistance.

Notice

Solderability of Tin plating termination chip might be deteriorated when low temperature soldering profile where peak solder temperature is below the Tin melting point is used. Please confirm the solderability of Tin plating termination chip before use.

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